

Serial No. : 2015-0806

DATE: 2015/08/06

ITEM:	CRYSTAL OSCILLATOR	
TYPE:	DSK321STD	
NOMINAL FREQUENCY:	32. 768kHz	
SPEC No.:	1XZA032768AD19	
	Please acknowledge receipt	of this specificatio

	RECEIPT
DATE	
RECEIVED	(signature) (name)

General Manufacture of Quartz Devices

# DAISHINKU CORP.

1389 Shinzaike, Hiraoka-cho, Kakogawa, Hyogo 675-0194 Japan Phone (81)79-425-3141 Fax (81)79-425-1134 http://www.kds.info/index\_en.htm

C.ENG.	A. Hishikawa

by signing and returning a copy to us.

ENG. Y. Momoo

1. Device Name TCXO

2. Model Name DSK321STD
3. Nominal Frequency 32.768 kHz
4. Mass 0.03g max.

# 5. Absolute Maximum Ratings

	<u> </u>			
	Item	Symbol	Rating	unit
1	Supply Voltage	Vcc	-0.3 ~ +6.0	V
2	Input Voltage	Vin	-0.3 ~ Vcc+0.3	V
3	Output current	Іоит	±10	mA
4	Storage Temperature Range	T_stg	-40 ~ +85	°C

# 6. Recommended Operating Conditions

Item		Symbol	Symbol Conditions		Rating		
	ileni	Syllibol	Conditions	min.	typ.	max.	unit
1	Supply Voltage	Vcc	Temperature compensation Voltage	+2.0	+3.3	+5.5	V
2	Paralle Capacitance	L_cmos		ı	ı	15	pF
3	Operating Temperature Range	T_use		-40	-	+85	°C

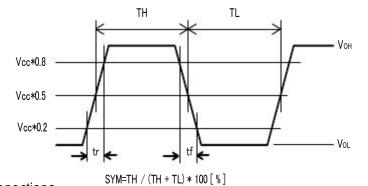
#### 7. Electrical Characteristics

# (Ta=-+25°C, Vcc=+3.3V, L\_cmos =15pF, unless otherwise noted)

	Item	Symbol	Conditions	Limits			unit
	nem Symbo		Conditions	min.	typ	max.	unit
1	Frequency Tolerance	f_tol	Ref. to Nominal Frequency Vcc=+3.3V,Ta=-40~+85°C	-5.0	-	+5.0	ppm
2	Current Consumption	Icc	Vcc=+3.3V, No Load Interval of temperature compensation : 0.5s	-	-	+2.5	μA
3	0 Level Voltage	Vol	IoL=0.1mA	-	ı	+0.4	V
4	1 Level Voltage	Vон	I <sub>он</sub> =-0.1 mA	Vcc-0.4	-	-	V
5	Symmetry	SYM	0.5xVcc level	40	-	60	%
6	Rise time	tr	20~80%Vcc	-	-	50	ns
7	Fall time	tf	80~20%Vcc	-	-	50	ns
8	Start up Time	tsт	From Vcc reaches the Supply Voltage, until the output	-	-	3	S

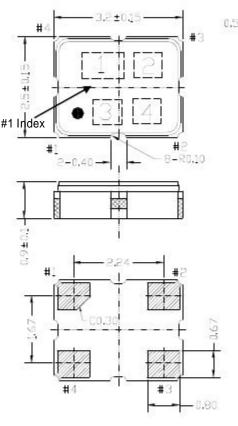
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# 8. Outline, Pin Connections

# <u>Outline</u>



#### Pin Connections

Pin No.	Connection
#1	Vcc
#2	GND
#3	Output
#4	Vcc

### Marking

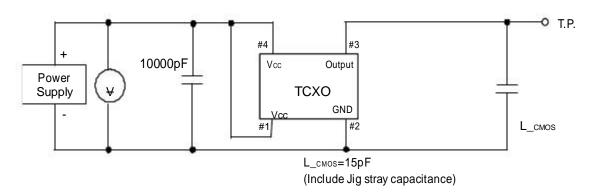
- (1) Frequency 32k (32.768kHz)
- (2) Model code TD (3) Logo D
- (4) Date code Year (1digit) +Week (2digits)

e.g.2015/01/01 -> 501

unit: mm

Dimensional Tolerance: ±0.15 (Unless otherwise noted)

#### 9. Measurement Circuit



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# 10. Mechanical Characteristics

All test is performed after 2times reflow (Clause. 13) except	ot 10.10	) (Resistance to soldering heat	i)
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		test is performed after 2times reflow (Clause.13) except 10.10 (R	
	Item	Description	Requirements
1	Drop	Natural drop (Hardwood board)	
		Height: 50cm	$\Delta f/f \leq \pm 5.0$ ppm
		Test cycle: 3cycles	
		Direction: Arbitrary direction	
2	Vibration	Sweep range : 10∼500Hz	
		Sweep speed : 11min/cycle	
		Amplitude: 1.5mm (10 255Hz)	$\Delta f/f \leq \pm 5.0$ ppm
		Acceleration: 200m/s 255~500Hz)	
		Direction: X,Y,Z, 3directions	
		Test cycle: 10cycles	
		Reference specification IEC 60068-2-6	
3	Shock	Acceleration: 1000m/s <sup>2</sup>	
		Direction : X,Y,Z, 6directions X,Y,Z	14/4 < 15 Oppose
		Duration : 6ms	$\Delta f/f \le \pm 5.0$ ppm
		Test cycle: 3cycles/each direction	
		Reference specification IEC 60068-2-27	
4	PCB bend strength	PWB:t=1.6mm	
-	. oz sona onong	Pressure speed : 1.0mm/s	
		Bend width: 1 2 3mm	
		Duration : 10±1s	
		Reference specification IEC 60068-2-21 Ue1	$\Delta f/f \leq \pm 5.0$ ppm
5	Adherence nature	PWB:t=1.6mm	
		Direction: X,Y, 2directions X,Y	No visible damage.
		Pressure: 10N	No leak damage.
		Duration: 10±1s	
		Reference specification IEC 60068-2-21 Ue3	
6	Package strength	Pressure: 10N	
		Duration: 10±1s	
		Reference specification IEC 60068-2-77	
7	Gross leak	It is immersed for 3min into +125±5°C	
		Chlorofluorocarbon (CFCs) liquid.	No continuous air bubbles.
		Reference specification IEC 60068-2-17	
8	Fine leak	It shall be measured by the helium leak detector	
		after pressurization for 60min by the pressure	Less than 1.0x10 Pa m/s.
		of (3.92±0.49)x10 <sup>5</sup> Pa in a helium gas atmosphere.	Less than 1.0x10 Pam/s.
		Reference specification IEC 60068-2-17	
9	Solderability	Solder bath temperature : +245±5°C	A new uniform coating of
		Duration: 3±0.3s	solder shall cover a
		Reference specification IEC 60068-2-58	minimum of 95% of the
L	D. data		surface being immersed.
10	Resistance to	1) Solder iron method	
	Soldering heat	Bit size: B(φ3)	$\Delta f/f \leq \pm 5.0$ ppm
		Bit temperature: +350±10°C	* *
		Duration: 3+1/-0s /each terminal	No visible damage.
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC 60068-2-20	
		2) Reflow	
		In refer to temperature profile shown in clause 14.	$\Delta f/f \leq \pm 5.0$ ppm
		Test cycle: 2cycles	No visible damage.
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC 60068-2-58	

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# 11. Environmental Characteristics

All test is performed after 2times reflow (Clause.13)

	Item	Description	fter 2times reflow (Clause.13)  Requirements
1	Low temperature	Temperature : -40±3°C	
	storage	Duration: 1000h	∆f/f ≦ ±10.0ppm
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC 60068-2-1 Ab	
2	High temperature	Temperature: +85±2°C	
	storage	Duration: 1000h	∆f/f ≦ ±10.0ppm
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC 60068-2-2 Bb	
3	Humidity	Temperature: +85±2°C	
		R.H.: 85±5%	A6/6 4.0. On n m
		Duration: 1000h	∆f/f ≦±10.0ppm
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC 60068-2-3	
4	HTB	Temperature: +85±2°C	
		Duration: 1000h	A6/6 10 Onn -
		BIAS: Max value of supply voltage	∆f/f ≦±10.0ppm
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC 60068-2-2 Bb	
5	Thermal shock	Thermal shock: -40±3°C: 0.5h ⇔+85±2°C: 0.5h	
		Test cycle: 200cycles	∆f/f ≤ ±10.0ppm
		Shift time: 2~3min	$\Delta W = \pm 10.0$
		It shall be measured after 2h at room temperature, humidity.	
		Reference specification IEC pub.68-2-14.Na	
6	ESD	Model : Machine Model(MM)	
		V=±200V(C1=200pF, R1=0Ω)	
		Number of times : 3times	$\Delta f/f \le \pm 5.0$ ppm
		Test Terminal : Each terminals	
		except common terminal.(Connect to test terminal)	
		Reference specification EIA/JESD22-A114	
		Model : Human Body Model(HBM)	
		V=±1500V(C1=100pF, R1=1500Ω)	
		Number of times : 3times	$\Delta f/f \le \pm 5.0$ ppm
		Test Terminal : Each terminals	
		except common terminal.(Connect to test terminal)	
		Reference specification EIA/JESD22-A115	

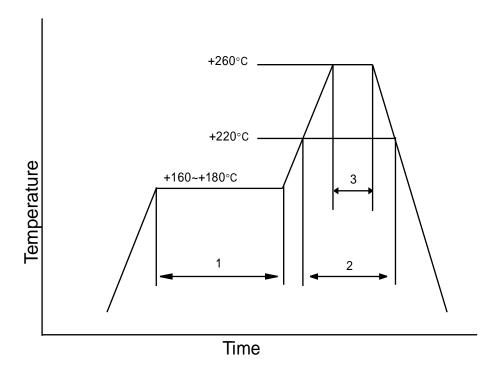
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# 12. Flatness of Terminal

When the component is placed on the flat surface, the gap from the connecting terminal shall not exceed 0.05 mm.



#### 13. Reflow Profile



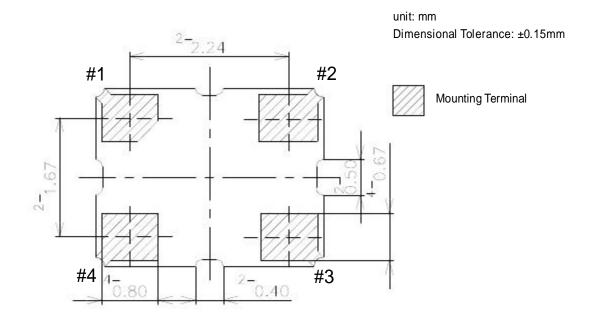
1	Preheat	+160~+180°C	120s
2	Primary Heat	+220°C	60s
3	Peak	+260°C	10s max.

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# 14. Terminals / Land Pattern Layout

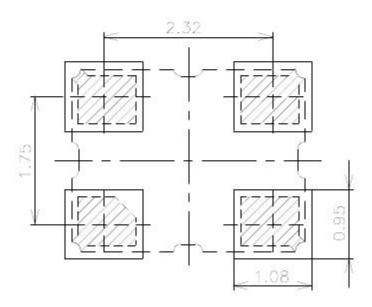
#### 14.1 Terminals

A through hole is not located on the bottom (mounting side).



# 14.2 Land Pattern Layout

The following land pattern is reference design. The electrical characteristic shall be satisfied with mounting to this land. The land pattern can be changed in the limits to which a test land and a mounting land are not connected. And it does not any effect to the electrical characteristics. Mask thickness recommends 0.12mm.



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#### 15. Packing Condition

- 15.1 Taping package
- (1) Emboss tape format and dimensions

See Fig.1

- (2) Quantity on reel 2000pcs. max. / reel
- (3) Taping specification See Fig.2

No lack of a product.

(4) Reel specification See Fig.3

(5) Taping material list See right table.

#### 15.2 Packing

The products packed in the antistatic bag.

\*Moisture sensitivity level : IPC/JEDEC Standard J-STD-033 / Level 1

No dry pack required and baking after re-storage is unnecessary.

#### 15.3 Packing box

Max 10 reels/packing box. However, in the case of less than 10 reels, It is contained by any boxes.

The space in a box is fill up with a cushion.

#### 15.4 Label detail

A Lot label is put on a reel and a shipping label and Pb-Free label is put on a packing box.

#### Lot label

TYPE (Model Name)
SPEC NO. (Spec. Number)
PARTS NO. (User's Parts Number)
LOT NO. (Lot Number)
FREQ. (Nominal Frequency)
Q'TY (Quantity)
KDS DAISHINKU CORP.

#### Shipping label

ITEM (Model Name)

SPEC (Spec. Number)

DELIVERY DATE (Delivery Date)

Q'TY (Quantity)

Taping material List

Emboss: PS (Conductivity)

Reel: PS (Conductivity)

Cover Tape: PET + Olefin Resin (Conductivity)

NOTES (User's Parts Number)

DAISHINKU CORP.

#### Pb-free Label



#### Lot label (Example)

#### 

#### Formation of a lot number

e.g. AH5101001

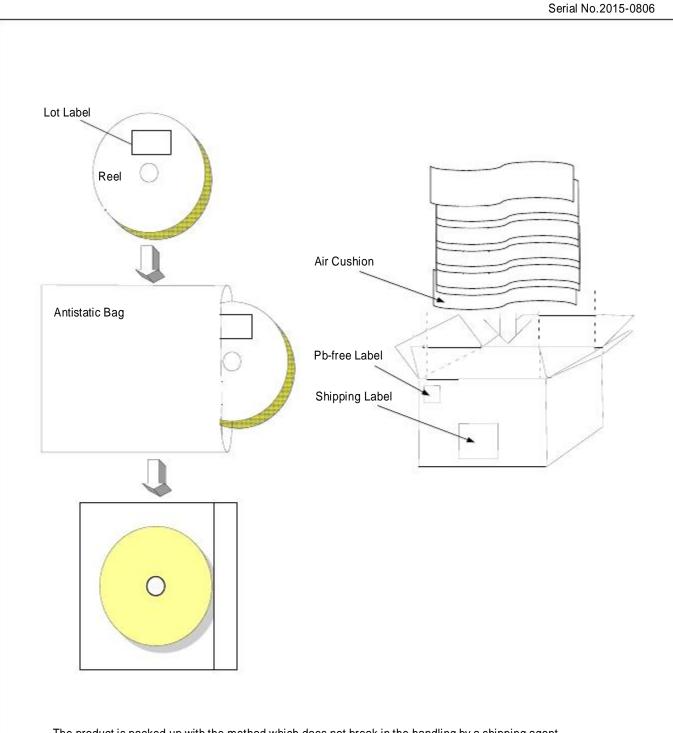
A H \_\_\_ 5101\_\_ 001 \_\_\_\_ Manufacturing site code Product code year/ month/ day Serial No.

The notation method of a manufacture year, month, and day. (4digits alphanumeric character)

YMDD (4digits) e.g.) 2015 /01 /01 → 5101
 Year 1digit (Last digit of Year)
 Month 1digit alphanumeric symbol
 DD Day 2digits numerical characters of day

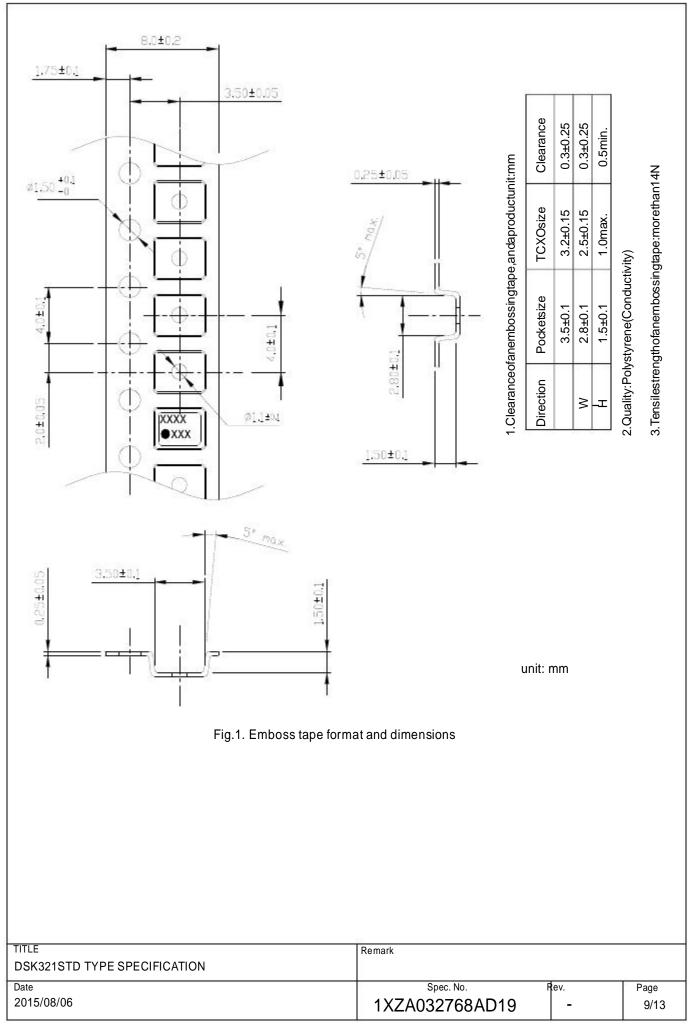
Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Symbol	1	2	3	4	5	6	7	8	9	0	N	D

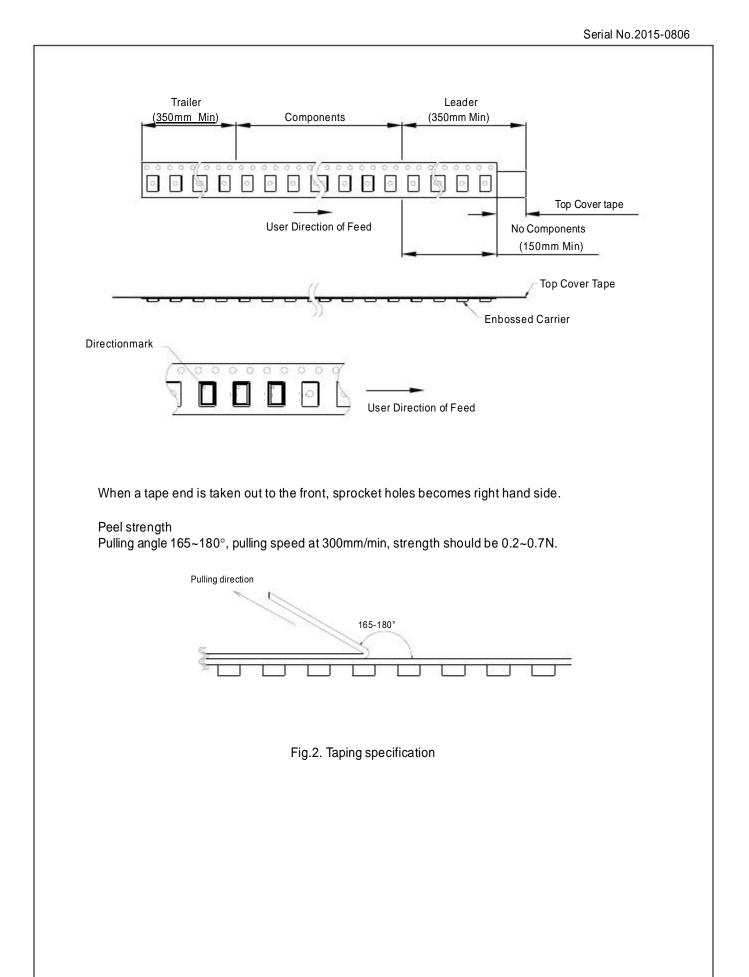
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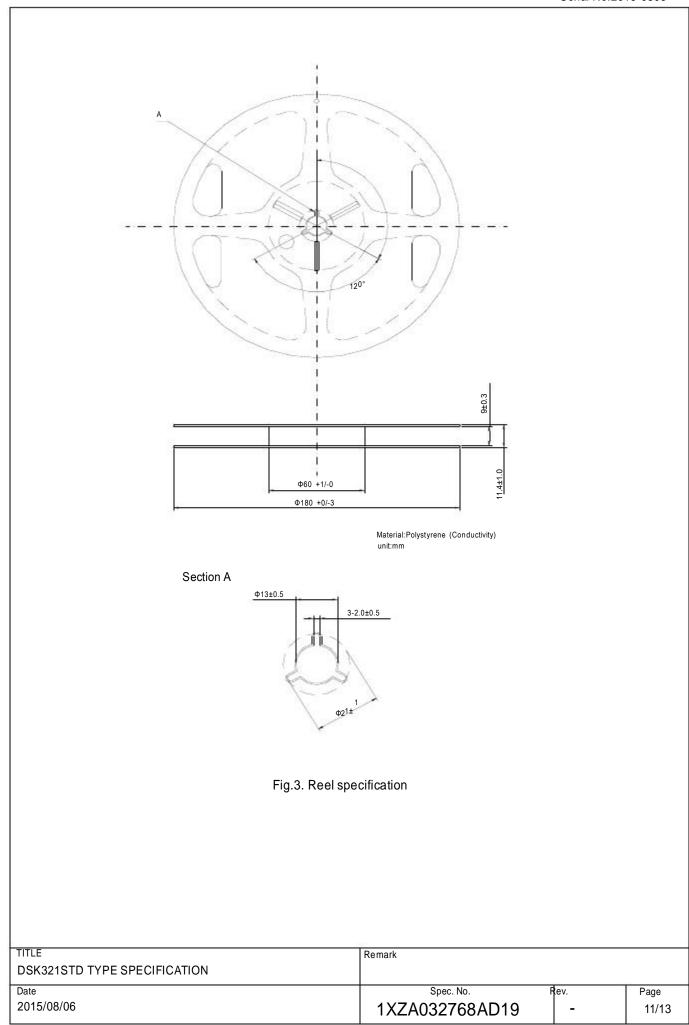
The product is packed up with the method which does not break in the handling by a shipping agent.

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#### 16. Notes on mounting and handling

- 17.1 Storage environment
  - (1) The temperature and humidity of a storage place, Please give +5~+40°C and 40~85% as a standard.
  - (2) Please use this product within one year from the packing label date of issue.
  - (3) Please avoid the place which generates corrosive gas, and the place with much dirt.
  - (4) Please keep it in a place with little temperature change.

Dew condensation arises owing to a rapid temperature change and solderability becomes bad.

- 16.2 Be cautions to static electricity and high voltage.
- 16.3 This product has sufficient durability to fall and vibration. However, conditions may change to the fall after mounting to a PWB, and vibration. When you should drop on a floor the PWB which mounted the product or too much shock is added. Please use after a performance check.
- 16.4 Please check that the curvature of the substrate at the time of substrate cutting does not affect product. Moreover, especially when a product is near the position of a PWB guide pin, and the position of PWB break, be careful.
- 16.5 The part concerned does not correspond to washing.
- 16.6 Please repair at +260°C in 10s with hot air or +350°C in 5s with solder Iron.

#### 17. Mandatory control

17.1 Ozone-depleting substance

It regulates by the U.S. air purifying method (November, 1990 establishment). ODS of CLASS1 and CLASS2 is not contained or used.

17.2 PBDE, PBBs

PBDE, PBBs are not contained into all the material currently used for this product.

17.3 RoHS

Following material restricted by RoHS (2011/65/EU) is not included or used. Lead, mercury, cadmium, hexavalent, chromium, PBB and PBDE.

17.4 Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances

All the material currently used for this product is based on "Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances". It is a registered material.

17.5 Lead

Leads, such as solder, are not used for this product. (Lead Free)

18. The country of origin / factory name / address

Country of origin: Japan

Factory name: DAISHINKU Corp. Tottori Production Div.
Address: 7-3-21 Wakabadai minami, Tottori 689-1112

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# 2015-0806 REVERSION RECORD

Rev. No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2015/08/06	-	Initial Release	A.Hishikawa	Y.Momoo	S.Fujihira